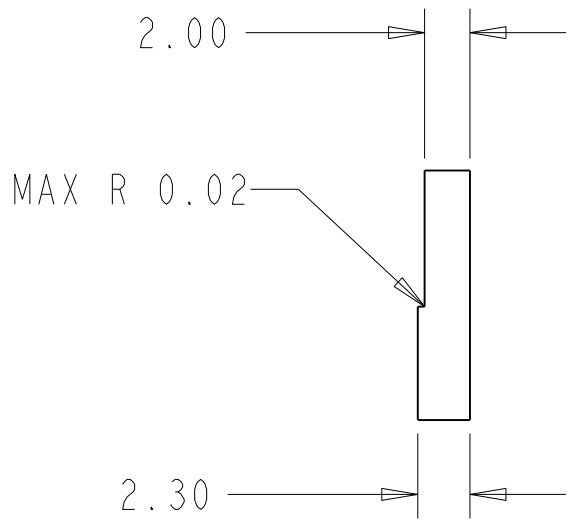
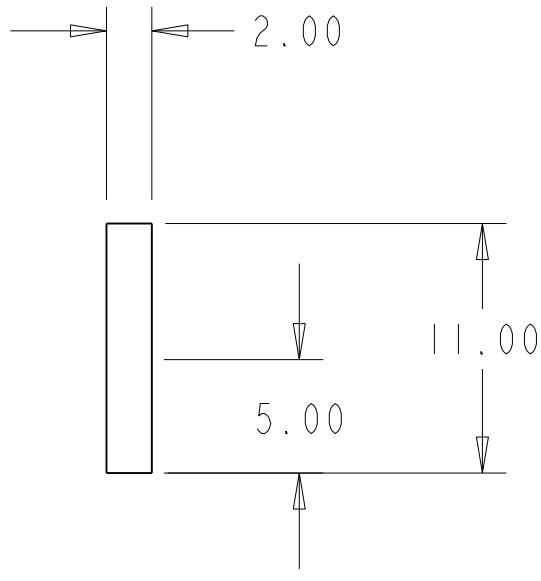
DWG. NO.	SIZE	REV.	SH.
21F3581		1	1





REV	DWG	CHK	DATE	CHANGES

DESCRIPTION: M55J CARBON-CARBON

MATERIAL

UNLESS OTHERWISE SPECIFIED

TOLERANCES: X.X ±0.1 | FRAC. ±1/64 | X.XX ±0.01 | Angles ±0.50° | X.XXX ±0.001 | FINISH 125 (µin)

DO NOT SCALE PRINT

THREADS ARE CLASS 2

CHAMFER ENDS OF ALL SCREW TREADS 30°

CUT ROUND, 1.5 THREAD RELIEF ON MACHINED THREADS

BREAK EDGES .016 MAX. ON MACHINED WORK

REMOVE BURRS, WELD SPLATTER & LOOSE SCALE

IN ACCORDANCE WITH ASME Y14.5M & B46.1

SHOP ORDERS

ACCT NO.	SEE J.O.	NO. REQD	120
DEL TO	J WIRTH		
SURFACE TREATMT			
IDENT METHOD	TAG		
PROJECT NUMBER	ATL-IP-ED-0036		
PROJECT NAME	US ATLAS SILICON SUBSYSTEM		
DWG BY	D UKEN	DATE	29-Jun-01
CHK BY	J WIRTH	DATE	18-FEB-01
APR BY	E ANDERSSEN	DATE	18-FEB-01

SER NO. -

DATE ISSD -

DATE REQD -

ERNEST ORLANDO LAWRENCE BERKELEY NATIONAL LABORATORY

UNIVERSITY OF CALIFORNIA - BERKELEY

ATLAS PIXEL DETECTOR

DISK SECTOR, MODULE LOCAL SUPPORT

BEAM HARDPOINT, SECTOR FACING SUPPORT

MICROFILMED:	DWG. TYPE	SHOWN ON	SCALE: 3.000	DO NOT SCALE PRINTS
	PART	21F352	SHEET 1 OF 1	
PATENT CLEAR:	DESIGN ACCT. NO.	CATEGORY CODE	DWG. NO.	SIZE / REV.
	ON J.O.	AP6110	21F3581	1

Rev. 1/8/2001 ATLAS

Dwg. File: 21F358 Model File: 21F358